











SN74LV07A

SCES337K-MAY 2000-REVISED OCTOBER 2014

# SN74LV07A Hex Buffers/Drivers With Open-Drain Outputs

#### **Features**

- 2-V to 5.5-V V<sub>CC</sub> Operation
- Typical V<sub>OLP</sub> (Output Ground Bounce)  $< 0.8 \text{ V at V}_{CC} = 3.3 \text{ V}, T_A = 25^{\circ}\text{C}$
- Typical V<sub>OHV</sub> (Output V<sub>OH</sub> Undershoot)  $> 2.3 \text{ V at V}_{CC} = 3.3 \text{ V}, T_A = 25^{\circ}\text{C}$
- Outputs are Disabled During Power Up and Power Down With Inputs Tied to V<sub>CC</sub>
- Support Mixed-Mode Voltage Operation on All Ports
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model
  - 200-V Machine Model
  - 1000-V Charged-Device Model

# 2 Applications

- Servers
- Telecom Infrastructures
- TV Set-Top Boxes

## Description

These hex buffers/drivers are designed for 2-V to 5.5-V V<sub>CC</sub> operation.

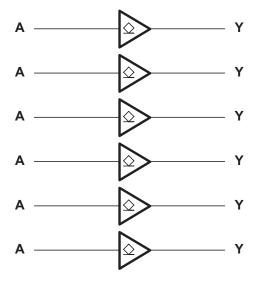
The SN74LV07A device performs the Boolean function Y = A in positive logic.

#### Device Information<sup>(1)</sup>

| PART NUMBER | PACKAGE    | BODY SIZE (NOM)    |  |  |
|-------------|------------|--------------------|--|--|
|             | TVSOP (14) | 3.60 mm x 4.40 mm  |  |  |
|             | SOIC (14)  | 8.65 mm x 3.91 mm  |  |  |
| SN74LV07A   | SOP (14)   | 10.30 mm x 5.30 mm |  |  |
|             | SSOP (14)  | 6.20 mm x 5.30 mm  |  |  |
|             | TSSOP (14) | 5.00 mm x 4.40 mm  |  |  |

(1) For all available packages, see the orderable addendum at the end of the data sheet.

# 4 Simplified Schematic





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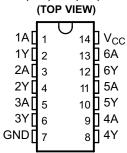
# **5 Revision History**

| CI | hanges from Revision J (October 2010) to Revision K                                   | Page                                   |
|----|---|--|
| •  | Updated document to new TI data sheet format  |  |
| •  | Deleted Ordering Information table.   | ······································ |
| •  | Added Handling Ratings table  | 4                                      |
| •  | Changed MAX operating temperature to 125°C in Recommended Operating Conditions table. | 4                                      |
| •  | Added Thermal Information table.  | !                                      |
| •  | Added Typical Characteristics.  | (                                      |
| •  | Added Detailed Description section  |  |
| •  | Added Application and Implementation section  | 8                                      |
| •  | Added Power Supply Recommendations and Layout sections                                | 9                                      |



# 6 Pin Configuration and Functions

SN74LV07A . . . D, DB, DGV, NS, OR PW PACKAGE



#### **Pin Functions**

| P               | IN  |     | PEODINE     |
|-----------------|-----|-----|-------------|
| NAME            | NO. | I/O | DESCRIPTION |
| 1A              | 1   | I   | 1A Input    |
| 1Y              | 2   | 0   | 1Y Output   |
| 2A              | 3   | I   | 2A Input    |
| 2Y              | 4   | 0   | 2Y Output   |
| ЗА              | 5   | I   | 3A Input    |
| 3Y              | 6   | 0   | 3Y Output   |
| 4A              | 9   | I   | 4A Input    |
| 4Y              | 8   | 0   | 4Y Output   |
| 5A              | 11  | I   | 5A Input    |
| 5Y              | 10  | 0   | 5Y Output   |
| 6A              | 13  | I   | 6A Input    |
| 6Y              | 12  | 0   | 6Y Output   |
| GND             | 7   | _   | Ground Pin  |
| V <sub>CC</sub> | 14  | _   | Power Pin   |

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## 7 Specifications

## 7.1 Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

|                 |  |   | MIN  | MAX | UNIT |  |
|-----------------|--|---|------|-----|------|--|
| $V_{CC}$        | Supply voltage range                               |   | -0.5 | 7   | V    |  |
| VI              | Input voltage range <sup>(2)</sup>                 | -0.5                                    | 7    | V   |      |  |
| Vo              | Voltage range applied to any output in the high-im | -0.5                                    | 7    | V   |      |  |
| I <sub>IK</sub> | Input clamp current                                | V <sub>I</sub> < 0                      |      | -20 | mA   |  |
| I <sub>OK</sub> | Output clamp current                               | V <sub>O</sub> < 0                      |      | -50 | mA   |  |
| Io              | Continuous output current                          | $V_O = 0$ to $V_{CC}$                   |      | -35 | mA   |  |
|                 | Continuous current through V <sub>CC</sub> or GND  | , |      |     |      |  |

<sup>(1)</sup> Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

## 7.2 Handling Ratings

|                    |                          |   | MIN             | MAX  | UNIT |
|--------------------|--------------------------|---|-----------------|------|------|
| T <sub>stg</sub>   | Storage temperature rang | e   | <del>-</del> 65 | 150  | ů    |
| V                  | Floatrootatio discharge  | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins (1)              | 0               | 2000 | \/   |
| V <sub>(ESD)</sub> | Electrostatic discharge  | Charged device model (CDM), per JEDEC specification JESD22-C101, all pins (2) |                 | 1000 | V    |

<sup>(1)</sup> JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

### 7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)(1)

|                 |                                     |  | MIN                   | MAX                 | UNIT |  |  |  |
|-----------------|-------------------------------------|--|-----------------------|---------------------|------|--|--|--|
| V <sub>CC</sub> | Supply voltage                      |  | 2                     | 5.5                 | V    |  |  |  |
|                 |                                     | V <sub>CC</sub> = 2 V                      | 1.5                   |                     |      |  |  |  |
| \/              | High level input valtage            | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | V <sub>CC</sub> × 0.7 |                     | V    |  |  |  |
| $V_{IH}$        | High level input voltage            | $V_{CC} = 3 \text{ V to } 3.6 \text{ V}$   | $V_{CC} \times 0.7$   |                     | V    |  |  |  |
|                 |                                     | V <sub>CC</sub> = 4.5 V to 5.5 V           | V <sub>CC</sub> × 0.7 |                     |      |  |  |  |
|                 |                                     | V <sub>CC</sub> = 2 V                      |                       | 0.5                 | V    |  |  |  |
| \/              | Low lovel input veltage             | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ |                       | $V_{CC} \times 0.3$ |      |  |  |  |
| $V_{IL}$        | Low level input voltage             | $V_{CC} = 3 \text{ V to } 3.6 \text{ V}$   |                       | $V_{CC} \times 0.3$ | V    |  |  |  |
|                 |                                     | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ |                       |                     |      |  |  |  |
| VI              | Input voltage                       |  | 0                     | 5.5                 | V    |  |  |  |
| Vo              | Output voltage                      |  | 0                     | 5.5                 | V    |  |  |  |
|                 |                                     | V <sub>CC</sub> = 2 V                      |                       | 50                  | μΑ   |  |  |  |
|                 | Low lovel output ourrent            | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ |                       | 2                   |      |  |  |  |
| l <sub>OL</sub> | Low level output current            | $V_{CC} = 3 \text{ V to } 3.6 \text{ V}$   |                       | 8                   | mA   |  |  |  |
|                 |                                     | V <sub>CC</sub> = 4.5 V to 5.5 V           |                       | 16                  |      |  |  |  |
|                 |                                     | V <sub>CC</sub> = 2.3 V to 2.7 V           |                       | 200                 |      |  |  |  |
| Δt/Δν           | Input transition rise and fall rate | V <sub>CC</sub> = 3 V to 3.6 V             |                       | ns/V                |      |  |  |  |
|                 |                                     | V <sub>CC</sub> = 4.5 V to 5.5 V           |                       |                     |      |  |  |  |
| T <sub>A</sub>  | Operating free-air temperature      |  | -40                   | 125                 | °C   |  |  |  |

All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs (SCBA004).

Product Folder Links: SN74LV07A

<sup>(2)</sup> The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

<sup>(2)</sup> JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.



#### 7.4 Thermal Information

|                      |  |         | SN74LV07A |         |         |         |      |  |  |  |  |
|----------------------|--|---------|-----------|---------|---------|---------|------|--|--|--|--|
|                      | THERMAL METRIC <sup>(1)</sup>                | D       | DB        | DGV     | NS      | PW      | UNIT |  |  |  |  |
|                      |  | 14 PINS | 14 PINS   | 14 PINS | 14 PINS | 14 PINS |      |  |  |  |  |
| $R_{\theta JA}$      | Junction-to-ambient thermal resistance       | 100.6   | 112.5     | 135.2   | 95.4    | 128.7   |      |  |  |  |  |
| $R_{\theta JC(top)}$ | Junction-to-case (top) thermal resistance    | 51.8    | 65.0      | 57.9    | 52.9    | 57.2    |      |  |  |  |  |
| $R_{\theta JB}$      | Junction-to-board thermal resistance         | 54.9    | 59.9      | 68.3    | 51.2    | 70.7    | °C/W |  |  |  |  |
| ΨЈТ                  | Junction-to-top characterization parameter   | 25.0    | 25.0      | 9.2     | 17.9    | 9.3     |      |  |  |  |  |
| ΨЈВ                  | Junction-to-board characterization parameter | 54.7    | 59.3      | 67.6    | 53.8    | 70.0    |      |  |  |  |  |

<sup>(1)</sup> For more information about traditional and new thermal metrics, see the IC Package Thermal Metrics application report (SPRA953).

#### 7.5 Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER        | TEST CONDITIONS                         | V <sub>cc</sub> | SI  | N74LV07A |       | -40°C to 125°C<br>SN74LV07A |      |    |  |    |  |  |    |    |
|------------------|---|-----------------|-----|----------|-------|-----------------------------|------|----|--|----|--|--|----|----|
|                  |   |                 | MIN | TYP MA   | X MIN | TYP                         | MAX  |    |  |    |  |  |    |    |
|                  | I <sub>OL</sub> = 50 μA                 | 2 V to 5.5 V    |     | 0        | .1    |                             | 0.1  |    |  |    |  |  |    |    |
| V                | I <sub>OL</sub> = 2 mA                  | 2.3 V           |     | 0        | .4    |                             | 0.4  | V  |  |    |  |  |    |    |
| $V_{OL}$         | I <sub>OL</sub> = 8 mA                  | 3 V             |     | 0.4      | 4     |                             | 0.44 | V  |  |    |  |  |    |    |
|                  | I <sub>OL</sub> = 16 mA                 | 4.5 V           |     | 0.5      | 55    |                             | 0.55 |    |  |    |  |  |    |    |
| I <sub>I</sub>   | V <sub>I</sub> = 5.5 V or GND           | 0 to 5.5 V      |     | ±1       |       | ±1                          |      | ±1 |  | ±1 |  |  | ±1 | μA |
| I <sub>OH</sub>  | $V_{I} = V_{IH},$ $V_{OH} = V_{CC}$     | 5.5 V           |     | ±2       | .5    |                             | ±2.5 | μΑ |  |    |  |  |    |    |
| Icc              | $V_I = V_{CC}$ or GND, $I_O = 0$        | 5.5 V           |     | 2        | 20    |                             | 20   | μA |  |    |  |  |    |    |
| I <sub>off</sub> | $V_I$ or $V_O = 0$ to 5.5 V             | 0               |     |          | 5     |                             | 5    | μA |  |    |  |  |    |    |
| Ci               | V <sub>I</sub> = V <sub>CC</sub> or GND | 3.3 V           |     | 1.6      |       | 1.6                         |      | pF |  |    |  |  |    |    |

# 7.6 Switching Characteristics, $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 3)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | LOAD T <sub>A</sub> = 25°C |     | SN74LV07A          |                     | -40°C to 125°C<br>SN74LV07A |     | UNIT |     |    |
|------------------|-----------------|----------------|----------------------------|-----|--------------------|---------------------|-----------------------------|-----|------|-----|----|
|                  | (INFOT)         | (001701)       | CAFACITANCE                | MIN | TYP                | MAX                 | MIN                         | MAX | MIN  | MAX |    |
| t <sub>PLH</sub> | Α               | Υ              | 0 45 -5                    |     | 6.6 <sup>(1)</sup> | 10.4 <sup>(1)</sup> | 1                           | 13  | 1    | 14  | 20 |
| t <sub>PHL</sub> | Α               | Y              | $C_L = 15 pF$              |     | 7.5 <sup>(1)</sup> | 10.4 <sup>(1)</sup> | 1                           | 13  | 1    | 14  | ns |
| t <sub>PLH</sub> | Α               | Υ              | C <sub>L</sub> = 50 pF     |     | 11.1               | 15.2                | 1                           | 18  | 1    | 19  | 20 |
| t <sub>PHL</sub> | А               | Υ              |                            |     | 9.6                | 15.2                | 1                           | 18  | 1    | 19  | ns |

<sup>(1)</sup> On products compliant to MIL-PRF-38535, this parameter is not production tested.

## 7.7 Switching Characteristics, $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 3)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | LOAD<br>CAPACITANCE    | 1   | <sub>A</sub> = 25°C |                    | SN74L\ | /07A | -40°C to 1<br>SN74LV |     | UNIT |
|------------------|-----------------|----------------|------------------------|-----|---------------------|--------------------|--------|------|----------------------|-----|------|
|                  | (INPOT)         | (001701)       | CAPACITANCE            | MIN | TYP                 | MAX                | MIN    | MAX  | MIN                  | MAX |      |
| t <sub>PLH</sub> | Α               | Υ              | 0 45 5                 |     | 5 <sup>(1)</sup>    | 7.1 <sup>(1)</sup> | 1      | 8.5  | 1                    | 9.5 |      |
| t <sub>PHL</sub> | Α               | Υ              | $C_L = 15 \text{ pF}$  |     | 5 <sup>(1)</sup>    | 7.1 <sup>(1)</sup> | 1      | 8.5  | 1                    | 9.5 | ns   |
| t <sub>PLH</sub> | Α               | Υ              | C <sub>L</sub> = 50 pF |     | 8.2                 | 10.6               | 1      | 12   | 1                    | 13  |      |
| t <sub>PHL</sub> | А               | Y              |                        |     | 6.6                 | 10.6               | 1      | 12   | 1                    | 13  | ns   |

(1) On products compliant to MIL-PRF-38535, this parameter is not production tested.

Product Folder Links: SN7

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# 7.8 Switching Characteristics, $V_{cc} = 5 V \pm 0.5 V$

operating free-air temperature range (unless otherwise noted) (see Figure 3)

| PARAMETER        | FROM    | TO<br>(OUTPUT) | LOAD<br>CAPACITANCE   | ٦   | Γ <sub>A</sub> = 25°C |                    | SN741 | _V07A | -40°C to 12<br>SN74LV0 |     | UNIT |
|------------------|---------|----------------|-----------------------|-----|-----------------------|--------------------|-------|-------|------------------------|-----|------|
|                  | (INPUT) | (001201)       | CAPACITANCE           | MIN | TYP                   | MAX                | MIN   | MAX   | MIN                    | MAX |      |
| t <sub>PLH</sub> | Α       | Υ              | 0 45 5                |     | 3.8                   | 5.5 <sup>(1)</sup> | 1     | 6.5   | 1                      | 7.2 |      |
| t <sub>PHL</sub> | Α       | Υ              | $C_L = 15 pF$         |     | 3.4 <sup>(1)</sup>    | 5.5 <sup>(1)</sup> | 1     | 6.5   | 1                      | 7.2 | ns   |
| t <sub>PLH</sub> | А       | Y              | 0 50-5                |     | 5.7                   | 7.5                | 1     | 8.5   | 1                      | 9.2 |      |
| t <sub>PHL</sub> | Α       | Υ              | $C_L = 50 \text{ pF}$ |     | 4.5                   | 7.5                | 1     | 8.5   | 1                      | 9.2 | ns   |

<sup>(1)</sup> On products compliant to MIL-PRF-38535, this parameter is not production tested.

## 7.9 Noise Characteristics(1)

 $V_{CC}$  = 3.3 V,  $C_L$  = 50 pF,  $T_A$  = 25°C

|             | PARAMETER                                     | MIN  | TYP  | MAX  | UNIT |
|-------------|---|------|------|------|------|
| $V_{OL(P)}$ | Quiet output, maximum dynamic V <sub>OL</sub> |      | 0.4  | 0.8  | V    |
| $V_{OL(V)}$ | Quiet output, minimum dynamic VOL             |      | -0.1 | -0.8 | V    |
| $V_{OH(V)}$ | Quiet output, minimum dynamic V <sub>OH</sub> |      | 3.2  |      | V    |
| $V_{IH(D)}$ | High-level dynamic input voltage              | 2.31 |      |      | V    |
| $V_{IL(D)}$ | Low-level dynamic input voltage               |      |      | 0.99 | V    |

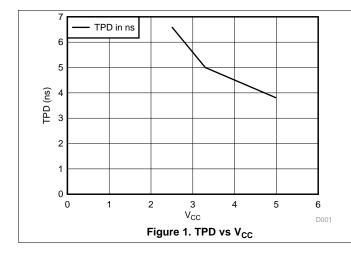
<sup>(1)</sup> Characteristics are for surface-mount packages only.

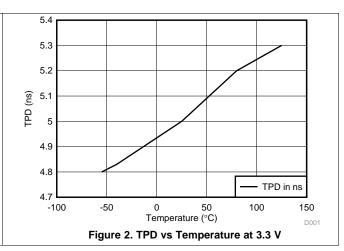
# 7.10 Operating Characteristics

 $T_{\Delta} = 25^{\circ}C$ 

|          | PARAMETER                     | TEST C                  | CONDITIONS | V <sub>CC</sub> | TYP | UNIT |
|----------|-------------------------------|-------------------------|------------|-----------------|-----|------|
| _        | Power dissipation capacitance | C <sub>L</sub> = 50 pF, | f 10 MH=   | 3.3 V           | 2.9 |      |
| $C_{pd}$ |                               |                         | f = 10 MHz | 5 V             | 5.3 | p⊦   |

# 7.11 Typical Characteristics



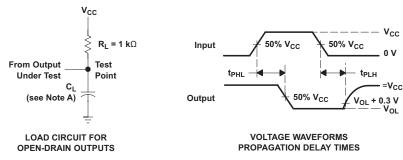


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#### 8 Parameter Measurement Information



- A. C<sub>L</sub> includes probe and jig capacitance.
- B. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O = 50 \ \Omega$ ,  $t_f \leq$  3 ns.
- C. The outputs are measured one at a time, with one input transition per measurement.

Figure 3. Load Circuit and Voltage Waveforms

## 9 Detailed Description

#### 9.1 Overview

The outputs of the SN74LV07A device are open drain and can be connected to other open-drain outputs to implement active-low wired-OR or active-high wired-AND functions. The maximum sink current is 16 mA at 5-V  $V_{CC}$ . Inputs can be driven from 2.5-V, 3.3-V, or 5-V (CMOS) devices. This feature allows the use of the SN74LV07A device as a translator in a mixed-system environment. This device is fully specified for partial power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, thus preventing a damaging current backflow through the device when it is powered down.

## 9.2 Functional Block Diagram



Figure 4. Logic Diagram, Each Buffer/Driver (Positive Logic)

#### 9.3 Feature Description

- · Wide operating voltage range
  - Operates from 2 V to 5.5 V
- Allows up or down voltage translation
  - Inputs and outputs accept voltages to 5.5 V
- I<sub>off</sub> feature
  - Allows voltages on the inputs and outputs when V<sub>CC</sub> is 0 V

#### 9.4 Device Functional Modes

Table 1. Function Table (Each Buffer/Driver)

| INPUT<br>A | OUTPUT<br>Y |
|------------|-------------|
| Н          | Н           |
| L          | L           |



## 10 Application and Implementation

#### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

## 10.1 Application Information

The SN74LV07A device is a low drive, open-drain CMOS device that can be used for a multitude of buffer type functions. The inputs are 5.5-V tolerant. The outputs are open drain and 5.5-V tolerant; thus, allowing the device to translate up to 5.5 V or down to any other voltage between GND and 5.5 V.

## 10.2 Typical Application

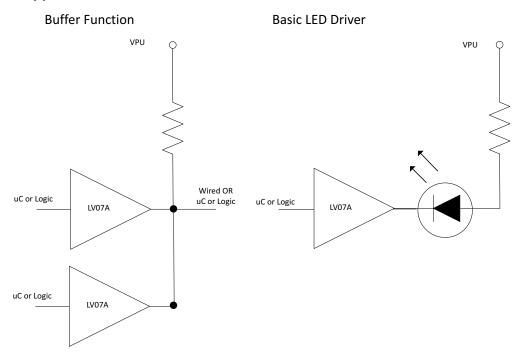


Figure 5. Typical Application Schematic

#### 10.2.1 Design Requirements

This device uses CMOS technology and is open drain, so it has low output drive only. Care should be taken to avoid bus contention, because it can drive currents that would exceed maximum limits. Parallel output drive can create fast edges into light loads, so routing and load conditions should be considered to prevent ringing.

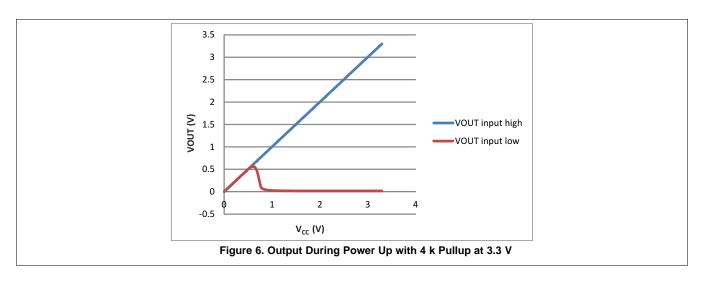
#### 10.2.2 Detailed Design Procedure

- 1. Recommended Input Conditions:
  - For rise time and fall time specifications, see Δt/ΔV in the Recommended Operating Conditions table.
  - For specified high and low levels, see V<sub>IH</sub> and V<sub>IL</sub> in the Recommended Operating Conditions table.
  - Inputs are overvoltage tolerant allowing them to go as high as 5.5 V at any valid V<sub>CC</sub>.
- 2. Recommended Output Conditions:
  - Load currents should not exceed 35 mA per output and 50 mA total for the part.



#### Typical Application (continued)

#### 10.2.3 Application Curves



## 11 Power Supply Recommendations

The power supply can be any voltage between the MIN and MAX supply voltage rating located in the Recommended Operating Conditions. Each V<sub>CC</sub> terminal should have a good bypass capacitor to prevent power disturbance. For devices with a single supply, 0.1 µF is recommended. If there are multiple V<sub>CC</sub> terminals then 0.01 µF or 0.022 µF is recommended for each power terminal. It is acceptable to parallel multiple bypass caps to reject different frequencies of noise. A 0.1 µF and 1 µF are commonly used in parallel. The bypass capacitor should be installed as close to the power terminal as possible for best results.

#### 12 Layout

#### 12.1 Layout Guidelines

When using multiple bit logic devices, inputs should not float. In many cases, functions or parts of functions of digital logic devices are unused. Some examples are when only two inputs of a triple-input AND gate are used, or when only 3 of the 4-buffer gates are used. Such input pins should not be left unconnected because the undefined voltages at the outside connections result in undefined operational states.

Specified in Figure 7 are rules that must be observed under all circumstances. All unused inputs of digital logic devices must be connected to a high or low bias to prevent them from floating. The logic level that should be applied to any particular unused input depends on the function of the device. Generally they will be tied to GND or V<sub>CC</sub>, whichever makes more sense or is more convenient. It is acceptable to float outputs unless the part is a transceiver.

#### 12.2 Layout Example

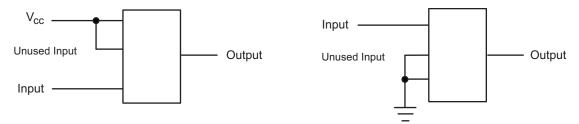


Figure 7. Layout Diagram



## 13 Device and Documentation Support

#### 13.1 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

Table 2. Related Links

| PARTS     | PRODUCT FOLDER | SAMPLE & BUY | TECHNICAL DOCUMENTS | TOOLS &<br>SOFTWARE | SUPPORT & COMMUNITY |
|-----------|----------------|--------------|---------------------|---------------------|---------------------|
| SN74LV07A | Click here     | Click here   | Click here          | Click here          | Click here          |

#### 13.2 Trademarks

All trademarks are the property of their respective owners.

### 13.3 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

## 13.4 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

## 14 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

Product Folder Links: SN74LV07A

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#### PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan     | Lead finish/<br>Ball material | MSL Peak Temp      | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|------------|--------------|--------------------|------|----------------|--------------|-------------------------------|--------------------|--------------|----------------------|---------|
| SN74LV07ADBR     | ACTIVE     | SSOP         | DB                 | 14   | 2000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 125   | LV07A                | Samples |
| SN74LV07ADGVR    | ACTIVE     | TVSOP        | DGV                | 14   | 2000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 125   | LV07A                | Samples |
| SN74LV07ADR      | ACTIVE     | SOIC         | D                  | 14   | 2500           | RoHS & Green | NIPDAU   SN                   | Level-1-260C-UNLIM | -40 to 125   | LV07A                | Samples |
| SN74LV07ANSR     | ACTIVE     | SO           | NS                 | 14   | 2000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 125   | 74LV07A              | Samples |
| SN74LV07APWR     | ACTIVE     | TSSOP        | PW                 | 14   | 2000           | RoHS & Green | NIPDAU   SN                   | Level-1-260C-UNLIM | -40 to 125   | LV07A                | Samples |
| SN74LV07APWRG3   | ACTIVE     | TSSOP        | PW                 | 14   | 2000           | RoHS & Green | SN                            | Level-1-260C-UNLIM | -40 to 125   | LV07A                | Samples |
| SN74LV07APWRG4   | ACTIVE     | TSSOP        | PW                 | 14   | 2000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 125   | LV07A                | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.



## **PACKAGE OPTION ADDENDUM**

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(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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## TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width     |
|----|---|
| В0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

| Device         | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|----------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74LV07ADBR   | SSOP            | DB                 | 14 | 2000 | 330.0                    | 16.4                     | 8.35       | 6.6        | 2.4        | 12.0       | 16.0      | Q1               |
| SN74LV07ADGVR  | TVSOP           | DGV                | 14 | 2000 | 330.0                    | 12.4                     | 6.8        | 4.0        | 1.6        | 8.0        | 12.0      | Q1               |
| SN74LV07ADR    | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| SN74LV07ADR    | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| SN74LV07ADR    | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.6        | 9.3        | 2.1        | 8.0        | 16.0      | Q1               |
| SN74LV07ANSR   | so              | NS                 | 14 | 2000 | 330.0                    | 16.4                     | 8.2        | 10.5       | 2.5        | 12.0       | 16.0      | Q1               |
| SN74LV07APWR   | TSSOP           | PW                 | 14 | 2000 | 330.0                    | 12.4                     | 6.85       | 5.45       | 1.6        | 8.0        | 12.0      | Q1               |
| SN74LV07APWR   | TSSOP           | PW                 | 14 | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| SN74LV07APWR   | TSSOP           | PW                 | 14 | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| SN74LV07APWRG3 | TSSOP           | PW                 | 14 | 2000 | 330.0                    | 12.4                     | 6.85       | 5.45       | 1.6        | 8.0        | 12.0      | Q1               |
| SN74LV07APWRG4 | TSSOP           | PW                 | 14 | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| SN74LV07APWRG4 | TSSOP           | PW                 | 14 | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |



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\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LV07ADBR   | SSOP         | DB              | 14   | 2000 | 356.0       | 356.0      | 35.0        |
| SN74LV07ADGVR  | TVSOP        | DGV             | 14   | 2000 | 356.0       | 356.0      | 35.0        |
| SN74LV07ADR    | SOIC         | D               | 14   | 2500 | 356.0       | 356.0      | 35.0        |
| SN74LV07ADR    | SOIC         | D               | 14   | 2500 | 353.0       | 353.0      | 32.0        |
| SN74LV07ADR    | SOIC         | D               | 14   | 2500 | 366.0       | 364.0      | 50.0        |
| SN74LV07ANSR   | SO           | NS              | 14   | 2000 | 356.0       | 356.0      | 35.0        |
| SN74LV07APWR   | TSSOP        | PW              | 14   | 2000 | 366.0       | 364.0      | 50.0        |
| SN74LV07APWR   | TSSOP        | PW              | 14   | 2000 | 356.0       | 356.0      | 35.0        |
| SN74LV07APWR   | TSSOP        | PW              | 14   | 2000 | 356.0       | 356.0      | 35.0        |
| SN74LV07APWRG3 | TSSOP        | PW              | 14   | 2000 | 366.0       | 364.0      | 50.0        |
| SN74LV07APWRG4 | TSSOP        | PW              | 14   | 2000 | 356.0       | 356.0      | 35.0        |
| SN74LV07APWRG4 | TSSOP        | PW              | 14   | 2000 | 356.0       | 356.0      | 35.0        |

## **MECHANICAL DATA**

# NS (R-PDSO-G\*\*)

# 14-PINS SHOWN

## PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



## DGV (R-PDSO-G\*\*)

#### **24 PINS SHOWN**

#### **PLASTIC SMALL-OUTLINE**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194

# D (R-PDSO-G14)

## PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.



PW (R-PDSO-G14)

## PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M—1994.
- B. This drawing is subject to change without notice.
  - Sody length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
- E. Falls within JEDEC MO-153



# PW (R-PDSO-G14)

# PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



## DB (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

#### **28 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

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